

#### SAS/ PCIe RIGHT ANGLE SMT RECEPTACLE

#### 1.0 SCOPE

This Product Specification covers the performance requirements of the SAS/PCIe High Speed Serialized Receptacle connector.

#### 2.0 PRODUCT DESCRIPTION

#### 2.1 PRODUCT NAME AND SERIES NUMBER(S)

#### Product Name

#### Series Number

SAS/PCIE, RIGHT ANGLE RECEPTACLE, SMT

78798

#### 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See the appropriate Sales Drawing for information on dimensions, materials, platings and markings.

#### 2.3 SAFETY AGENCY APPROVALS

UL FILE	:	E29179 VOL 10
CSA	:	1422869 (LR19980)

	E RELEASE: PECIFICATION IS BASE	D ON DESIGN OBJECT	IVES AND IS STRICTL	Y TENTAT	IVE.
		Y EXIST, BUT THIS SPE ADDITIONAL TESTING ,		ECT TO CH	IANGE
DAGED	ON THE RESULTS OF	ADDITIONAL LESTING	AND EVALUATION.		
REVISION:	ECR/ECN INFORMATION:	TITLE:	SAS/ PCle		SHEET No.
Α	<u>ECM:</u> 109385	RIGHT ANG	<b>SLE SMT RECEP</b>	ACLE	<b>1</b> of <b>8</b>
	<u>DATE:</u> 2016/10/17	2.8	85mm HEIGHT		
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPRO	OVED BY:
PS PS	S-78798-001	SKANG	CWANG25	SH	IONG

TEMPLATE FILENAME: PRODUCT\_SPEC[SIZE\_A4](V.1).DOC



#### 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extend specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In addition, in event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

#### 4.0 RATINGS

4.1 VOLTAGE

30 Volts Max.

#### 4.2 CURRENT

Power section (per pin):

- Continuous Current 1.5A DC
- Peak Current 2.5A for 1.5s
- Peak Current Pre-charge 6A for 1ms

Signal section (per pin):

- Continuous current 500mA

#### 4.3 TEMPERATURE

Operating:  $0^{\circ}C$  to  $+ 55^{\circ}C$ Non-Operating:  $-40^{\circ}C$  to  $+ 85^{\circ}C$ 

#### 5.0 PERFORMANCE

#### 5.1 ELECTRICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Low Level Contact Resistance (LLCR)	Subject mated contacts assembled in housing to <b>20</b> mV maximum open circuit at <b>100</b> mA maximum. (EIA 364-23)	<b>45</b> mΩ MAXIMUM [Initial] <b>15</b> mΩ MAXIMUM [Delta change from Initial]

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molex®		PRODUCT SPECIFIC	CATION
2	Temperature Rise (via current cycling) (Power Segment)	Mount connector to a test PCB with ½ oz copper layer. Wire power pins P1, P2, P8 and P9 in parallel for power. Wire ground pins P4, P5, P6, P10 and P12 in parallel for return. Supply <b>6A</b> total DC current to the power pins in parallel, returning from the parallel ground pins. Measure and record temperature after <b>96</b> <b>hours (45</b> minutes ON and <b>15</b> minutes OFF per hour).	<ul> <li>1.5 A per pin MINIMUM</li> <li>Temperature rise shall not exceed 30°C at any point in the connector when contacts are powered</li> <li>Still Air at Ambient temperature 25±3 °C</li> </ul>
3	Insulation Resistance	Subject a voltage of <b>500</b> VDC for <b>1</b> minute, measure the insulation resistance between adjacent terminals of the mated and unmated connector assemblies. (EIA 364-21)	<b>1000</b> Megohms MINIMUM
4	Dielectric Withstanding Voltage	Subject a voltage of <b>500</b> VAC for <b>1</b> minute between adjacent terminals of mated and unmated connector at sea level. (EIA 364-20 Method B)	No breakdown

### 5.2 MECHANICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
5	Connector Mate and Unmate Forces	Mate and Unmate connector assemblies at a rate of <b>25.4</b> mm per minute. (EIA 364-13)	Mate force - <b>50</b> N MAXIMUM Unmate force - <b>5</b> N MINIMUM [Initial & After durability]
6	Durability	<b>25</b> cycles for cable application; <b>500</b> cycles for backplane application. All at a maximum rate of <b>200</b> cycles/hr. (EIA 364-09)	No Physical damage <b>15</b> mΩ MAXIMUM [Delta change from Initial]
7	Terminal Retention Force	Apply axial pull out force on terminal in the housing at a rate of <b>25.4</b> mm per minute.	Port 1: <b>3.50</b> N MINIMUM Port 2: <b>2.20</b> N MINIMUM [Before and after Preconditioning]

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ſ	<u>DATE:</u> 2016/10/17	2.85mm HEIGHT		500	
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ma			PRODUCT SPECIFIC	CATION
	8	Physical Shock	Subject mated connector to <b>50</b> g's half-sine shock pulses of <b>11</b> msec duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of <b>18</b> shocks. (EIA 364-27 Condition A) Test set-up per Section 8.0	No Physical damage No discontinuities of <b>1</b> μs or longer duration <b>15</b> mΩ MAXIMUM [Delta change from Initial]
	9	Random Vibration	Subject mated connector to <b>3.10</b> g's RMS. <b>15</b> minutes in each of the three mutually perpendicular planes. (EIA 364-28 Test Condition VII Test letter D) Test set-up per Section 8.0	No discontinuities of <b>1</b> μs or longer duration <b>15</b> mΩ MAXIMUM [Delta change from Initial]

### 5.3 ENVIRONMENTAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
10	Humidity	Subject the connector to temperature and humidity of <b>40</b> °C with <b>90</b> % to <b>95</b> % RH for <b>96</b> hours. (EIA 364-31 Method II Test Condition A)	No Physical damage <u>Insulation Resistance</u> <b>1000</b> Megohms MINIMUM [Initial & after test] <u>Dielectric Withstanding</u> <u>Voltage</u> No breakdown
11	Solderability	Unmated Connector. Steam age for 8 hours +/- 15 minutes. Solder Time: <b>3</b> ± 0.5 seconds Solder Temperature: <b>260</b> ± 5°C Flux type: ROL0 (JESD 22-B-102 Condition C)	<b>95</b> % MININUM Solder coverage
12	Temperature Life	Subject mated connector to temperature life at + <b>85</b> °C for <b>500</b> hours. (EIA 364-17 Method A Test Condition 3)	No Physical damage <b>15</b> mΩ MAXIMUM [Delta change from Initial]
13	Thermal Shock	Subject connector to <b>10</b> cycles between - <b>55</b> °C and + <b>85</b> °C. (EIA 364-32 Method A Test Condition I)	No Physical damage

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		PRODUCT SPECIFIC	ATION
14		Subject connector to the following condition: SO <sub>2</sub> gas concentration: <b>0.1</b> ppm. NO <sub>2</sub> gas concentration: <b>0.2</b> ppm. H <sub>2</sub> S gas concentration: <b>0.01</b> ppm. CL <sub>2</sub> gas concentration: <b>0.01</b> ppm. Temperature: <b>30</b> ± 1 °C Relative Humidity: <b>70</b> ± 2 % Half of the samples are exposed unmated for <b>7</b> days, then mated for the remaining <b>7</b> days. The other half of the samples mated for full <b>14</b> days test period. (EIA 364-65, Class IIA)	No Physical damage <b>15</b> mΩ MAXIMUM [Delta change from Initial]
15	Resistance to Soldering Heat	Refer to Section 9.0 for Soldering profile	No damage in appearance of connector

### 6.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage.

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#### 7.0 TEST SEQUENCES

Test Group A to E are covered by SAS Specification.

Test Group → Test or Examination ↓	Α	В	С	D	Е	F	G
Low Level Contact Resistance (LLCR)	2,4	3,7	2,4,6		2,5,7		
Insulation Resistance				2,6			
Dielectric Withstanding Voltage				3,7			
Current Rating (Temperature Rise)			7				
Mate Force		2					
Unmate Force		8					
Durability	3	4 <sup>(a)</sup>			3 <sup>(a)</sup>		
Physical Shock		6					
Vibration		5					
Humidity				5			
Temperature Life			3				
Reseating (manually unplug/plug three times)			5		6		
Thermal Shock				4			
Mixed Flowing Gas					4		
Resistance to Soldering Heat						3	
Terminal Retention Force						2,4	
Solderability							1
Note – (a) Preconditioning, 50 cycles fo cycle is at a maximum rate o				equireme	nt. The ma	ate and un	mate
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ON: <u>ECR/ECN INFORMATION:</u> <u>TITLE:</u> SAS/ PCIe <u>ECM:</u> 109385 <b>RIGHT ANGLE SMT RECEPTACLE</b>							

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#### 8.0 VIBRATION/SHOCK TEST SET-UP

SAS/PCIe Receptacle mated with SAS/PCIe Plug (For Reference Only)







